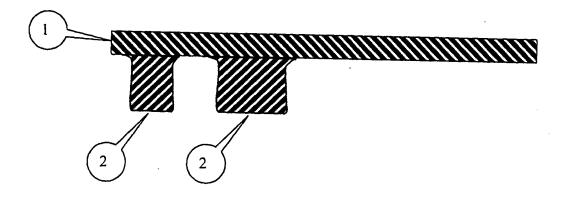
Figure 1

Express Mail No.: EV318424785US Deposited: 09/22/03
Title: PROCESS FOR MANUFACTURE OF PRINTED CIRCUIT
80ARDS WITH THICK COPPER POWER CIRCUITRY AND THIN
COPPER SIGNAL CIRCUITRY ON THE SAME LAYER
Inventors: Giuseppe Pedretti, et al.
Filed: Not Yet Filed
Agent: Marc A. Brockhaus
SHEET 1 0F 5

Deposited: 09/22/03

TRINTED CIRCUITRY
FOR PRINTED CIRCUITRY

HEET 1 OF 5 Formal Drawl



Express Mail No.: EV318424785US
Title: PROCESS FOR MANUFACTURE OF PRINTED CIRCUIT
BOARDS WITH THICK COPPER POWER CIRCUITRY AND THIN
COPPER SIGNAL CIRCUITRY ON THE SAME LAYER
Inventors: Gluseppe Pedretti, et al.
Fried: Not Yet Filed
Agent: Marc A. Brockhaus
SHEET 2 OF 5

Deposited: 09/22/03

PRINTED CIRCUITRY AND THIN
EXAMINET: UNK
EXAMINET: Unk
Dkt. No.: 8245.060
Formal Drawings

Figure 2a

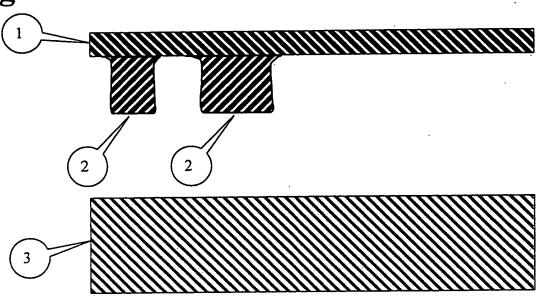
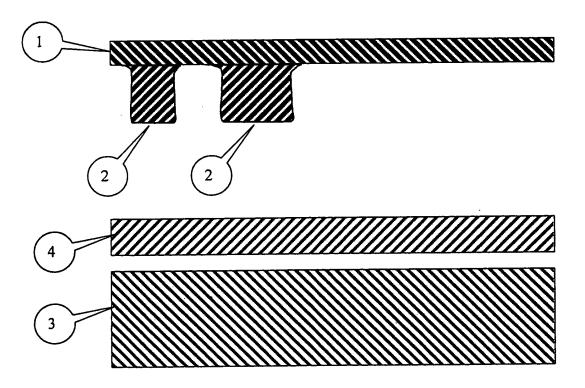
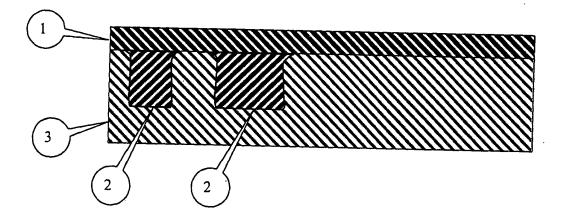


Figure 2b



Express Mail No.: EV318424785US Deposited: 09/22/03
Title: PROCESS FOR MANUFACTURE OF PRINTED CIRCUIT
BOARDS WITH THICK COPPER POWER CIRCUITRY AND THIN
COPPER SIGNAL CIRCUITRY ON THE SAME LAYER
Inventors: Giuseppe Pedretti, et al.
Filed: Not Yet Filed Examiner: Unk
Agent: Marc A. Brockhaus Dkt. No.: 8245.060
SHEET 3 OF S Formal Drawings

Figure 2c



Express Mail No.: EV31842478SUS Deposited: 09/22/03
Title: PROCESS FOR MANUFACTURE OF PRINTED CIRCUIT
BOARDS WITH THICK COPPER POWER CIRCUITRY AND THIN
COPPER SIGNAL CIRCUITRY ON THE SAME LAYER
Inventors: Giuseppe Pedretti, et al.
Filed: Not Yet Filed Examiner: Unk
Agent: Marc A. Brockhaus Dkt. No.: 8245.060
SHEET 4 OF 5 Formal Drawings

Figure 3a

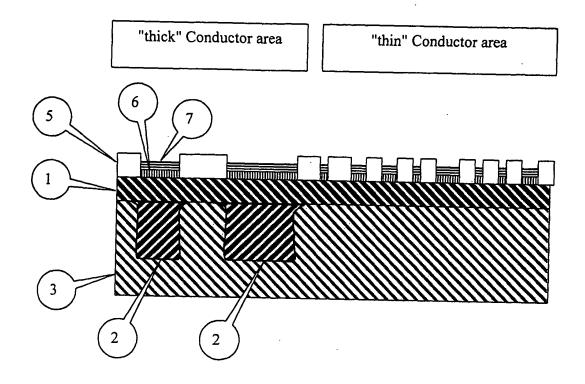
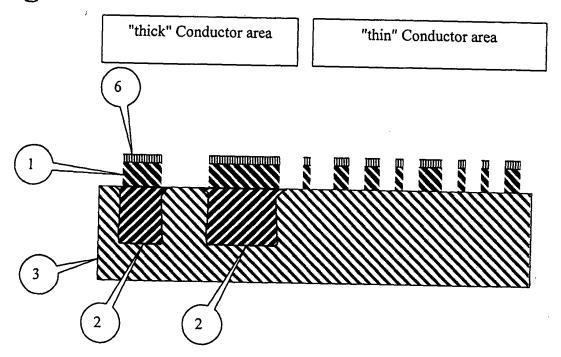


Figure 3b



Express Mail No.: EV318424785US Deposited: 09/22/03
Title: PROCESS FOR MANUFACTURE OF PRINTED CIRCUIT
BOARDS WITH THICK COPPER POWER CIRCUITRY AND THIN
COPPER SIGNAL CIRCUITRY ON THE SAME LAYER
Inventors: Giuseppe Pedretti, et al. Group: Unk
Filed: Not Yet Filed Examiner: Unk
Agent: Marc A. Brockhaus Dkt. No.: 8245.060
SHEET 5 OF 5 Formal Drawings

Figure 4

"thick" Conductor area

"thin" Conductor area

